

# MicroPressure Board Mount Pressure Sensors

32332628

MPR Series—Compact, High Accuracy, Compensated/Amplified

Issue A

**Datasheet** 



## **DESCRIPTION**

The MPR Series is a very small piezoresistive silicon pressure sensor offering a digital output for reading pressure over the specified full scale pressure span and temperature range. It is calibrated and compensated over a specific temperature range for sensor offset, sensitivity, temperature effects, and non-linearity using an on-board Application Specific Integrated Circuit (ASIC). This product is designed to meet the requirements of higher volume medical (consumer and nonconsumer) devices and commercial appliance applications.

# **VALUE TO CUSTOMERS**

- Very small form factor: Enables portability by addressing weight, size, and space restrictions; occupies less area on the PCB.
- Wide pressure ranges simplify use.
- Enhances performance: Output accelerates performance through reduced conversion requirements and direct interface to microprocessors.
- Value solution: Cost-effective, higher volume solution with configurable options.
- Meets IPC/JEDEC J-STD-020D.1 Moisture Sensitivity Level
  1 requirements: Allows avoidance of thermal and mechanical
  damage during solder reflow attachment and/or repair that
  lesser rated sensors may incur; allows unlimited floor life
  when stored as specified (simplifying storage and reducing
  scrap); eliminates lengthy bakes prior to reflow, and allows
  for lean manufacturing due to stability and usability shortly
  after reflow.
- Low power/energy efficient: Reduces system power requirements and enables extended battery life.

# **FEATURES**

- 5 mm x 5 mm [0.20 in x 0.20 in] package footprint
- Calibrated and compensated
- $\pm 40 \text{ mbar to } \pm 2.5 \text{ bar } | \pm 4 \text{ kPa to } \pm 250 \text{ kPa} | \pm 0.6 \text{ psi to } \pm 30 \text{ psi}$
- 24-bit digital I<sup>2</sup>C or SPI-compatible output
- IoT (Internet of Things) ready interface
- Low power consumption (<10 mW typ.), energy efficient
- Stainless steel pressure port
- Medical and food grade gel options
- · Compatible with a variety of liquid media
- Absolute and gage pressure types
- Total Error Band after customer auto-zero: As low as ±1.5 %FSS
- Compensated temperature range: 0°C to 50°C [32°F to 122°F]
- REACH and RoHS compliant
- Meets IPC/JEDEC J-STD-020D.1 Moisture Sensitivity Level 1

## **DIFFERENTIATION**

- Application-specific design addresses various application needs and challenges.
- Digital output: Plug and play feature enables ease of implementation and system level connectivity.
- Total Error Band: Provides true performance over the compensated temperature range, which minimizes the need to test and calibrate every sensor, thereby potentially reducing manufacturing cost; improves sensor accuracy and offers ease of sensor interchangeability due to minimal partto-part variation. (See Figure 1.)

## **POTENTIAL APPLICATIONS**

- Consumer medical: Non-invasive blood pressure monitoring, negative-pressure wound therapy, breast pumps, mobile oxygen concentrators, airflow monitors, CPAP water tanks, and medical wearables
- Non-consumer medical: Invasive blood pressure monitors, ambulatory blood pressure measurement
- Industrial: Air braking systems, gas and water meters
- Consumer: Coffee machines, humidifiers, air beds, washing machines, dishwashers

## **PORTFOLIO**

The MPR Series joins an extensive line of board mount pressure sensors for potential use in medical, industrial, and consumer applications.

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## Figure 1. TEB Components for the MPR Series

Total Error Band (TEB) is a single specification that includes the major sources of sensor error. TEB should not be confused with accuracy, which is actually a component of TEB. TEB is the worst error that the sensor could experience.

Honeywell uses the TEB specification in its datasheet because it is the most comprehensive measurement of a sensor's true accuracy. Honeywell also provides the accuracy specification in order to provide a common comparison with competitors' literature that does not use the TEB specification.

Many competitors do not use TEB—they simply specify the accuracy of their device. Their accuracy specification, however, may exclude certain parameters. On their datasheet, the errors are listed individually. When combined, the total error (or what would be TEB) could be be significant.

# Sources of Error Offset Full Scale Span Pressure Non-Linearity Pressure Hysteresis Pressure Non-Repeatability Thermal Effect on Offset Thermal Hysteresis Thermal Hysteresis

## Table 1. Absolute Maximum Ratings<sup>1</sup>

Characteristic	Min.	Max.	Unit	
Supply voltage (V <sub>supply</sub> )	-0.3	3.6	Vdc	
Voltage on any pin	-0.3	V <sub>supply</sub> + 0.3	V	
ESD susceptibility (human body model)	_	2	kV	
Storage temperature	-40 [-40]	85 [185]	°C [°F]	
Soldering peak reflow temperature and time	15 s max. at 250°C [482°F]			

<sup>&</sup>lt;sup>1</sup>Absolute maximum ratings are the extreme limits the device will withstand without damage.

## **Table 2. Environmental Specifications**

Characteristic	Parameter
Humidity:	
all external surfaces	0 %RH to 95 %RH, non-condensing
internal surfaces of Liquid Media Option (S,F, L)	0 %RH to 100 %RH, condensing
internal surfaces of Dry Gases Option (N)	0 %RH to 95 %RH, non-condensing
Vibration	15 g, 10 Hz to 2 Hz
Shock	100 g, 6 ms duration
Solder reflow	J-STD-020-D.1 Moisture Sensitivity Level 1 (unlimited shelf life when stored at <30°C/85 %RH)

## Table 3. Wetted Materials

Component	Non-Gel Version	Gel Protected Version
Ports and covers	304 stainless steel	304 stainless steel
Substrate	FR4	_
Adhesives	ероху	gel
Electronic components	silicon, glass, copper, gold	-

## **Table 4. Sensor Pressure Types**

Pressure Type	Description
Absolute	Output is proportional to the difference between applied pressure and a built-in vacuum reference.
Gage	Output is proportional to the difference between applied pressure and atmospheric (ambient) pressure.

# **Table 5. Operating Specifications**

Characteristic	Min.	Тур.	Max.	Unit
Supply voltage (V <sub>supply</sub> ): <sup>1, 2</sup>	3.0	3.3	3.6	Vdc
Supply current at 3.3 Vdc: standby mode active mode	_ _	0.0005 1.7	_ _	mA
Power consumption	_	10	_	mW
Operating temperature range <sup>3</sup>	-40 [-40]	_	85 [185]	°C [°F]
Compensated temperature range <sup>4</sup>	0 [32]	_	50 [122]	°C [°F]
Startup time (power up to data ready)	_	_	0.3	ms
Data rate	_	200	_	samples per second
I <sup>2</sup> C/SPI voltage level: low high	_ 80		20 -	%V <sub>supply</sub>
Pull up on MISO, SCLK, SS, MOSI	1	_	_	kOhm
Total Error Band after customer zero	_	_	±1.5	%FSS BFSL <sup>6</sup>
Accuracy <sup>5</sup>	_	_	±0.25	%FSS BFSL <sup>6</sup>
Resolution	13.0	_	_	bits

<sup>&</sup>lt;sup>1</sup>Ratiometricity of the sensor (the ability of the device output to scale to the supply voltage): Achieved within the specified operating voltage.

<sup>&</sup>lt;sup>2</sup>The sensor is not reverse polarity protected. Incorrect application of supply voltage or ground to the wrong pin may cause electrical failure.

<sup>&</sup>lt;sup>3</sup>Operating temperature range: The temperature range over which the sensor will produce an output proportional to pressure.

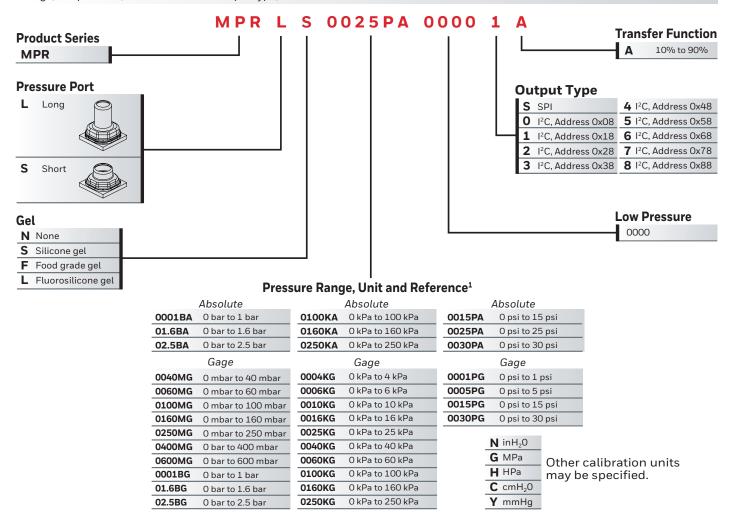
<sup>&</sup>lt;sup>4</sup>Compensated temperature range: The temperature range over which the sensor will produce an output proportional to pressure within the specified performance limits (Total Error Band).

<sup>&</sup>lt;sup>5</sup>**Accuracy:** The maximum deviation in output from a Best Fit Straight Line (BFSL) fitted to the output measured over the pressure range. Includes all errors due to pressure non-linearity, pressure hysteresis, and non-repeatability.

<sup>&</sup>lt;sup>6</sup>Full Scale Span (FSS): The algebraic difference between the output signal measured at the maximum (Pmax.) and minimum (Pmin.) limits of the pressure range. (See Figure 2 for pressure ranges.)

Figure 2. Product Nomenclature

For example, MPRLS0025PA00001A defines an MPR Series pressure sensor, long port, silicone gel, 0 psi to 25 psi absolute pressure range, low pressure, I<sup>2</sup>C, Address 0x18 output type, 10% to 90% transfer function.



The MPR series is available in a number of configurations. Contact Honeywell or your authorized distributor for a current list of available configurations. For applications above 250,000 units per year, additional configurations are available.

Table 6. Pressure Range Specifications for ±40 mbar to ±2.5 bar

Pressure Range (See Figure 2.)	Pressu	re Range	Unit	Over Pressure <sup>1</sup>	Burst Pressure <sup>2</sup>	Total Error Band after Customer	
(See Figure 2.)	Pmin.	Pmax.		riessuie	Pressure	Auto-Zero <sup>3</sup> (%FSS)	
			Absolute				
0001BA	0	1	bar	4	8	±1.5	
01.6BA	0	1.6	bar	4	8	±1.5	
02.5BA	О	2.5	bar	4	8	±1.5	
			Gage				
0040MG	О	40	mbar	350	700	±1.5	
0060MG	0	60	mbar	350	700	±1.5	
0100MG	О	100	mbar	350	700	±1.5	
0160MG	0	160	mbar	350	700	±1.5	
0250MG	0	250	mbar	350	700	±1.5	
0400MG	0	400	mbar	4000	8000	±1.5	
0600MG	0	600	mbar	4000	8000	±1.5	
0001BG	0	1	bar	4	8	±1.5	
01.6BG	0	1.6	bar	4	8	±1.5	
02.5BG	0	2.5	bar	4	8	±1.5	

<sup>&</sup>lt;sup>1</sup> **Overpressure:** The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified this applies to all available pressure ports at any temperature with the operating temperature range.

<sup>&</sup>lt;sup>2</sup> **Burst Pressure:** The maximum pressure that may be applied to any port of the product without causing escape of pressure media. Product should not be expected to function after exposure to any pressure beyond the burst pressure.

<sup>&</sup>lt;sup>3</sup> **Total Error Band after Customer Auto-Zero:** The maximum deviation from the ideal transfer function over the entire compensated pressure range for a minimum of 24 hours after an auto-zero operation. Includes all errors due to full scale span, pressure non-linearity, pressure hysteresis, and thermal effect on span.

Table 7. Pressure Range Specifications for ±4 kPa to ±250 kPa

Pressure Range (See Figure 2.)	Pressu	re Range	Unit	Over Pressure <sup>1</sup>	Burst Pressure <sup>2</sup>	Total Error Band after Customer
(See Figure 2.)	Pmin.	Pmax.		Pressure	Pressure	Auto-Zero³ (%FSS)
			Absolute	I	l.	
0100KA	0	100	kPa	400	800	±1.5
0160KA	0	160	kPa	400	800	±1.5
0250KA	0	250	kPa	400	800	±1.5
			Gage			
0004KG	0	4	kPa	35	70	±1.5
0006KG	0	6	kPa	35	70	±1.5
0010KG	0	10	kPa	35	70	±1.5
0016KG	0	16	kPa	35	70	±1.5
0025KG	0	25	kPa	35	70	±1.5
0040KG	0	40	kPa	400	800	±1.5
0060KG	0	60	kPa	400	800	±1.5
0100KG	0	100	kPa	400	800	±1.5
0160KG	0	160	kPa	400	800	±1.5
0250KG	0	250	kPa	400	800	±1.5

<sup>&</sup>lt;sup>1</sup> Overpressure: The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified this applies to all available pressure ports at any temperature with the operating temperature range.

<sup>&</sup>lt;sup>2</sup> Burst Pressure: The maximum pressure that may be applied to any port of the product without causing escape of pressure media. Product should not be expected to function after exposure to any pressure beyond the burst pressure.

<sup>&</sup>lt;sup>3</sup> Total Error Band after Customer Auto-Zero: The maximum deviation from the ideal transfer function over the entire compensated pressure range for a minimum of 24 hours after an auto-zero operation. Includes all errors due to full scale span, pressure non-linearity, pressure hysteresis, and thermal effect on span.

Table 8. Pressure Range Specifications for ±6 psi to ±30 psi

Pressure Range (See Figure 2.)	Pressur	e Range	Unit	Over Pressure <sup>1</sup>	Burst Pressure <sup>2</sup>	Total Error Band after Customer
	Pmin.	Pmax.				Auto-Zero³ (%FSS)
			Absolute			
0015PA	0	15	psi	60	120	±1.5
0025PA	0	25	psi	60	120	±1.5
0030PA	0	30	psi	60	120	±1.5
			Gage			
0001PG	0	1	psi	5	10	±1.5
0005PG	0	5	psi	60	120	±1.5
0015PG	0	15	psi	60	120	±1.5
0030PG	0	30	psi	60	120	±1.5

<sup>&</sup>lt;sup>1</sup> **Overpressure:** The maximum pressure which may safely be applied to the product for it to remain in specification once pressure is returned to the operating pressure range. Exposure to higher pressures may cause permanent damage to the product. Unless otherwise specified this applies to all available pressure ports at any temperature with the operating temperature range.

<sup>&</sup>lt;sup>2</sup> **Burst Pressure:** The maximum pressure that may be applied to any port of the product without causing escape of pressure media. Product should not be expected to function after exposure to any pressure beyond the burst pressure.

<sup>&</sup>lt;sup>3</sup> **Total Error Band after Customer Auto-Zero:** The maximum deviation from the ideal transfer function over the entire compensated pressure range for a minimum of 24 hours after an auto-zero operation. Includes all errors due to full scale span, pressure non-linearity, pressure hysteresis, and thermal effect on span.

## 1.0 General Information

Please see pages 16-18 for product dimensions, pinouts, and tape and reel dimensions.

## 1.1 Start-up Timing

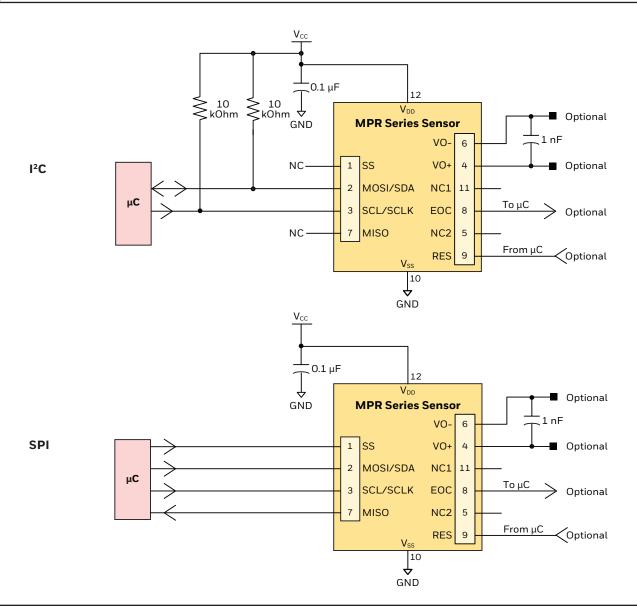
On power-up, the MPR Series sensor is able to receive the first command after 1 ms from when the  $V_{DD}$  supply is within operating specifications. The MPR Series sensor can begin the first measurement after 2.5 ms from when the  $V_{DD}$  supply is operational. Alternatively, instead of a power-on reset, a reset and new power-up sequence can be triggered by an IC-reset signal (high low) at the RES pin.

## 1.2 Power Supply Requirement

Verify that system power to the sensor meets the  $V_{DD}$  rising slope requirement (minimum  $V_{DD}$  rising slope is at least 10 V/ms). If not, use the RES pin to bring the sensor out of reset once the system power has stabilized.

# 1.3 I<sup>2</sup>C and SPI Reference Circuits (see Figure 3)

Figure 3. I<sup>2</sup>C and SPI Reference Circuits



## 2.0 I<sup>2</sup>C Communication

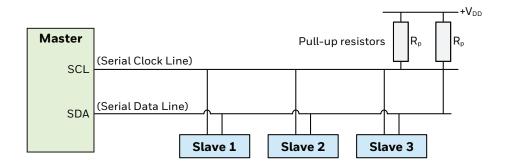
# 2.1 I<sup>2</sup>C Introduction (See Figure 4.)

The  $I^2C$  bus is a simple, serial 8-bit oriented computer bus for efficient  $I^2C$  (Inter-IC) control. It provides good support for communication between different ICs across short circuit-board distances, such as interfacing microcontrollers with various low speed peripheral devices. For detailed specifications of the  $I^2C$  protocol, see Version 2.1 (January 2000) of the  $I^2C$  Bus Specification (source: NXP Semiconductor at https://www.nxp.com/docs/en/user-guide/UM10204.pdf).

Each device connected to the bus is software addressable by a unique address and a simple Master/Slave relationship that exists at all times. The output stages of devices connected to the bus are designed around an open collector architecture. Because of this, pull-up resistors to  $+V_{DD}$  must be provided on the bus. Both SDA and SCL are bidirectional lines, and it is important to system performance to match the capacitive loads on both lines. In addition, in accordance with the  $I^2C$  specification, the maximum allowable capacitance on either line is 400 pF to ensure reliable edge transitions at 400 kHz clock speeds.

When the bus is free, both lines are pulled up to  $+V_{DD}$ . Data on the  $I^2C$  bus can be transferred at a rate up to 100 kbit/s in the standard-mode, or up to 400 kbit/s in the fast-mode.

Figure 4. I<sup>2</sup>C Bus Configuration



## 2.2 I<sup>2</sup>C Data Transfer

The MPR Series I<sup>2</sup>C sensors are designed to work as Slaves and will therefore only respond to requests from a Master device. Following the address and read bit from the Master, the MPR Series sensors are designed to output up to 4 bytes of data. The first data byte is the Status Byte (8-bit) and the second to fourth bytes are the compensated pressure output (24-bit).

## 2.3 I<sup>2</sup>C Sensor Address

Each MPR Series  $I^2C$  sensor is referenced on the bus by a 7-bit slave address. The default address for the MPR Series is 24 (0x18). Other available standard addresses are: 08 (0x08), 40 (0x28), 56 (0x38), 72 (0x48), 88 (0x58), 104 (0x68), 120 (0x78). (Other custom values are available. Please contact Honeywell Customer Service with questions regarding custom Slave addresses.)

# 2.4 I<sup>2</sup>C Pressure Reading (See Table 9.)

To read out a compensated pressure reading, the Master generates a START condition and sends the sensor Slave address followed by a read bit (1). After the sensor generates an acknowledge, it will transmit up to 4 bytes of data. The first data byte is the Status Byte (8-bit) and the second to fourth bytes are the compensated pressure output (24-bit). The Master must acknowledge the receipt of each byte, and can terminate the communication by sending a Not Acknowledge (NACK) bit followed by a Stop bit after receiving the required bytes of data.

#### 2.5 I<sup>2</sup>C Status Byte (See Table 9.)

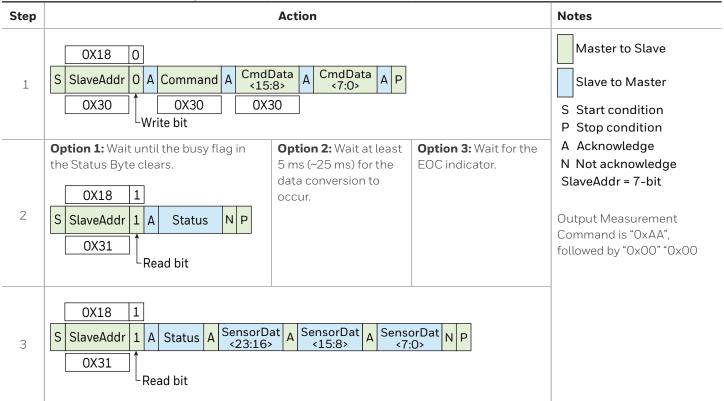
Table 9. I<sup>2</sup>C Status Byte Explanation

Bit and Meaning	Status	Comment
7	always 0	-
6 Power indication	1 = device is powered 0 = device is not powered	Needed for the SPI Mode where the Master reads all zeroes if the device is not powered or in power-on reset (POR).
5 Busy flag	1 = device is busy,	Indicates that the data for the last command is not yet available. No new commands are processed if the device is busy.
4	always 0	_
3	always 0	_
2 Memory integrity/error flag	O = integrity test passed 1 = integrity test failed	Indicates whether the checksum-based integrity check passed or failed; the memory error status bit is calculated only during the power-up sequence.
1	always O	_
0 Math saturation	1 = internal math saturation has occurred	_

#### 2.6 I<sup>2</sup>C Communication Steps

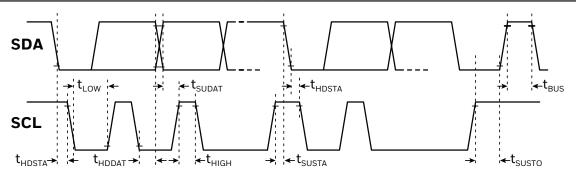
To communicate with the MPR Series I<sup>2</sup>C sensor with an I<sup>2</sup>C Slave Address of 0x18, follow the steps in Table 10.

Table 10. I<sup>2</sup>C Communication Steps



#### 2.7 I<sup>2</sup>C Timing and Level Parameters (See Figure 5.)

Figure 5. I<sup>2</sup>C Bus Timing Diagram and Parameters



Characteristic	Abbreviation	Min.	Тур.	Max.	Unit
SCLK clock frequency	f <sub>SCL</sub>	100	_	400	kHz
Start condition hold time relative to SCL edge	t <sub>HDSTA</sub>	0.1	_	_	μs
Minimum SCLK clock low width <sup>1</sup>	t <sub>LOW</sub>	0.6	_	_	μs
Minimum SCLK clock high width <sup>1</sup>	t <sub>HIGH</sub>	0.6	_	_	μs
Start condition setup time relative to SCL edge	t <sub>susta</sub>	0.1	_	_	μs
Data hold time on SDA relative to SCL edge	t <sub>HDDAT</sub>	0	_	_	μs
Data setup time on SDA relative to SCL edge	t <sub>sudat</sub>	0.1	_	_	μs
Stop condition setup time on SCL	t <sub>susto</sub>	0.1	_	_	μs
Bus free time between stop condition and start condition	t <sub>BUS</sub>	2	_	_	μs
Output level low	Out <sub>low</sub>	_	0	0.2	V <sub>DD</sub>
Output level high	Out <sub>high</sub>	0.8	1	_	V <sub>DD</sub>
Pull-up resistance on SDA and SCL	Rp	1	_	50	kOhm

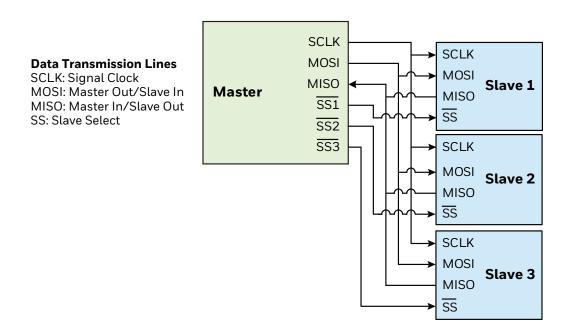
<sup>&</sup>lt;sup>1</sup>Combined low and high widths must equal or exceed minimum SCLK period.

#### 3.0 **SPI Communication**

#### 3.1 Introduction

The Serial Peripheral Interface (SPI) is a simple bus system for synchronous serial communication between one Master and one or more Slaves. It operates either in full-duplex or half-duplex mode, allowing communication to occur in either both directions simultaneously, or in one direction only. The Master device initiates an information transfer on the bus and generates clock and control signals. Slave devices are controlled by the Master through individual Slave Select (SS) lines and are active only when selected. The MPR Series SPI sensors operate in full-duplex mode only, with data transfer from the Slave to the Master. This data transmission uses four, unidirectional bus lines. The Master controls SCLK, MOSI and SS; the Slave controls MISO. (See Figure 6.)

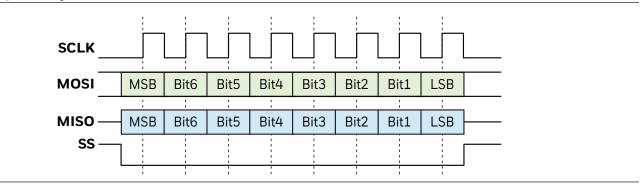
Figure 6. SPI Bus Configuration



#### 3.2 **SPI Data Transfer**

Starting communication with the MPR Series SPI sensors begins by de-asserting the Slave Select (SS) line. At this point, the sensor is no longer idle, and will begin sending data once a clock is received. MPR Series SPI sensors are configured for SPI operation in mode 0 (clock polarity is 0 and clock phase is 0). (See Figure 7.)





Once the clocking begins, the MPR Series SPI sensor is designed to output up to 4 bytes of data. The first data byte is the Status Byte (8-bit) and the second to fourth bytes are the compensated pressure output (24-bit).

#### 3.3 **SPI Pressure Reading**

To read out a compensated pressure reading, the Master generates the necessary clock signal after activating the sensor with the Slave Select (SS) line. The sensor will transmit up to 4 bytes of data. The first data byte is the Status Byte (8-bit) and the second to fourth bytes are the compensated pressure output (24-bit). The Master can terminate the communication by stopping the clock and deactivating the SS line.

#### 3.4 **SPI Status Byte**

The SPI status byte contains the bits shown in Table 11.

#### 3.5 **SPI Communication Steps**

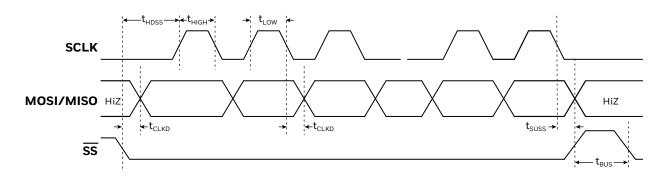
To communicate with the MPR Series SPI sensor, follow the steps in Table 11.

**Table 11. SPI Communication Steps** 

Step				Action		Notes
1	MOSI MISO The dat	OxAA  Command other than NOP  Status  a on MISO	0x00  CmdData <15:8>  Status  depend on	Ox00  CmdData <7:0>  Status  the preceding command. Discar	d the data on the MISO line.	Master to Slave  Slave to Master  Output Measurement
2	-	1: Wait unting in the State  OxFO  Command = NOP  Status		<b>Option 2:</b> Wait for less than 5 ms (~25 ms) for the data conversion to occur.	<b>Option 3:</b> Wait for the EOC indicator.	Command is "0xAA", followed by "0x00", "0x00".  NOP Command is "0xF0".
3	MOSI MISO	OxFO  Command = NOP  Status	Ox00  CmdData OOHex  SensorDat <24:16>	Ox00 Ox00  CmdData CmdData OO <sub>Hex</sub> SensorDat SensorDat <15:8>  CmdData CmdData OO <sub>Hex</sub>	1	

#### 3.6 **SPI Timing and Level Parameters (See Figure 8.)**

Figure 8. SPI Bus Timing Diagram and Parameters



Characteristic	Abbreviation	Min.	Тур.	Max.	Unit
SCLK clock frequency	f <sub>SCL</sub>	50	_	800	kHz
SS drop to first clock edge	t <sub>HDSS</sub>	2.5	_	_	μs
Minimum SCLK clock low width <sup>1</sup>	t <sub>LOW</sub>	0.6	_	_	μs
Minimum SCLK clock high width <sup>1</sup>	t <sub>HIGH</sub>	0.6	_	_	μs
Clock edge to data transition	t <sub>CLKD</sub>	0	_	_	μs
Rise of SS relative to last clock edge	t <sub>suss</sub>	0.1	_	_	μs
Bus free time between rise and fall of SS	t <sub>BUS</sub>	2	_	_	μs
Output level low	Out <sub>low</sub>	_	0	0.2	V <sub>DD</sub>
Output level high	Out <sub>high</sub>	0.8	1	_	V <sub>DD</sub>

<sup>&</sup>lt;sup>1</sup>Combined low and high widths must equal or exceed minimum SCLK period.

#### 4.0 **MPR Series Sensor Output Pressure Calculation**

The MPR Series sensor output can be expressed by the transfer function of the device as shown in Equation 1:

# **Equation 1: Pressure Sensor Transfer Function**

Output = 
$$\frac{\text{(Output}_{max.} - \text{Output}_{min.})}{P_{---} - P_{---}} * (Pressure - P_{min.}) + Output_{min.}$$

Rearranging this equation to solve for Pressure, we get Equation 2:

# **Equation 2: Pressure Output Function**

$$Pressure = \underbrace{(Output - Output_{min.}) * (P_{max.} - P_{min.})}_{Output_{max.} - Output_{min.}} + P_{min.}$$

Where:

Output<sub>max.</sub> = output at maximum pressure [counts]

Output<sub>min.</sub> = output at minimum pressure [counts]

P<sub>max.</sub> = maximum value of pressure range [bar, psi, kPa, etc.]

P<sub>min</sub> = minimum value of pressure range [bar, psi, kPa, etc.]

Pressure = pressure reading [bar, psi, kPa, etc.]

Output = digital pressure reading [counts]

**Example:** Calculate the pressure for a -1 psi to 1 psi gage sensor with a 10% to 90% calibration, and a pressure output of 14260634 (decimal) counts:

Output<sub>max</sub> = 15099494 counts (90% of  $2^{24}$  counts or 0xE66666)

Output<sub>min</sub> = 1677722 counts (10% of  $2^{24}$  counts or 0x19999A)

 $P_{max.} = 1 psi$ 

 $P_{min} = -1 psi$ 

Pressure = pressure in psi

Output = 14260634 counts

Pressure = 
$$\left[ \frac{(14260634-1677722)*(1-(-1))}{15099494-1677722} \right] + (-1)$$

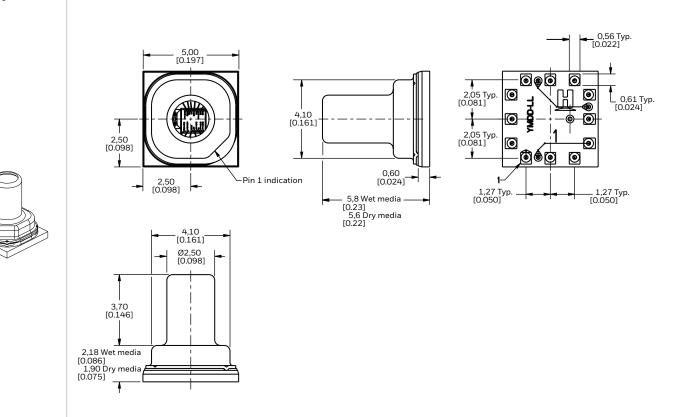
Pressure = 25165824 + (-1)

13421772

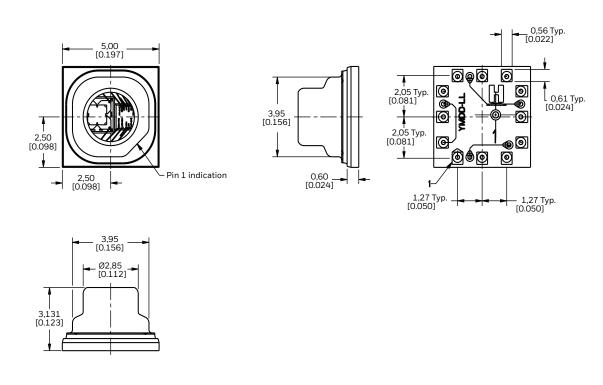
Pressure = 0.875 psi

Figure 9. Product Dimensions (For reference only: mm [in].)

# Long port

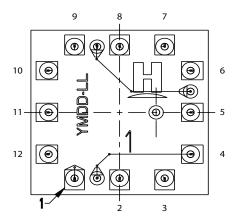


# **Short port**





# **Table 9. Pinout and Functionality**



Pad Number	Name	Description
1	SS	Slave Select: Chip select for SPI sensor
2	MOSI/SDA	Master Out/Slave In: Data in for SPI sensor; data in/out for I <sup>2</sup> C sensor
3	SCLK/SCL	Clock input for SPI and I <sup>2</sup> C sensor
4	VO+	V <sub>OUT+</sub> pin in piezoresistive Wheatstone Bridge: Anti-aliasing filter can be connected between VO+ and VO- as recommended in Figure 1-1
5	NC2	No connection
6	VO-	$V_{\text{OUT-}}$ pin in piezoresistive Wheatstone Bridge: Anti-aliasing filter can be connected between VO- and VO+ as recommended in Figure 1-1
7	MISO	Master In/Slave Out: Data output for SPI sensor
8	EOC	End-of-conversion indicator: This pin is set high when a measurement and calculation have been completed and the data is ready to be clocked out
9	RES	Reset: This pin can be connected and used to control safe resetting of the sensor. RES is active-low; a $V_{DD}$ - $V_{SS}$ - $V_{DD}$ transition at the RES pin leads to a complete sensor reset
10	V <sub>SS</sub>	Ground reference voltage signal
11	NC1	No connection
12	V <sub>DD</sub>	Positive supply voltage

Figure 10. Recommended PCB Pad Layout

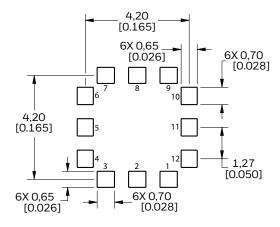
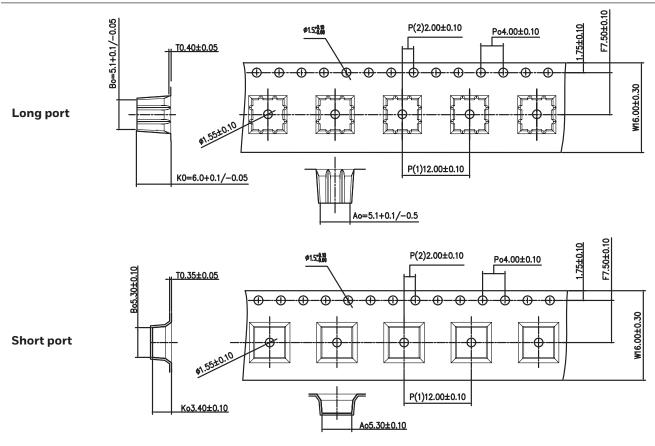
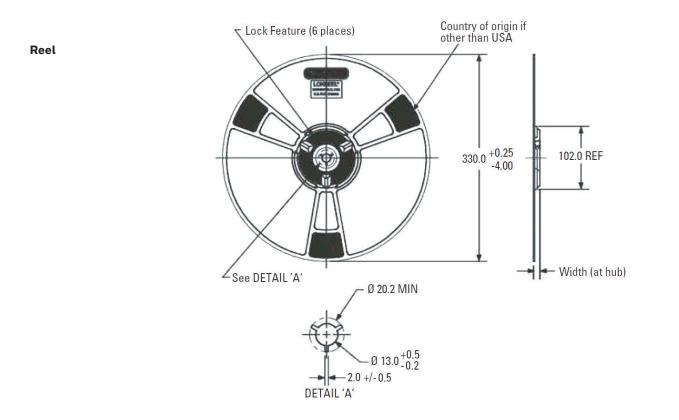


Figure 11. Product Tape and Reel Dimensions (For reference only: mm.)





## **ADDITIONAL INFORMATION**

The following associated literature is available on sensing.honeywell.com:

- Product line guide
- Product range guide
- Installation instructions
- Application information
- · CAD models
- Product images

## For more information

Honeywell Sensing and Internet of Things services its customers through a worldwide network of sales offices and distributors. For application assistance, current specifications, pricing or the nearest Authorized Distributor, visit sensing.honeywell.com or call:

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